
SECURITIES AND EXCHANGE COMMISSION

Washington, DC 20549

FORM 6-K

**REPORT OF FOREIGN PRIVATE ISSUER
PURSUANT TO RULE 13a-16 OR 15d-16 OF
THE SECURITIES EXCHANGE ACT OF 1934**

For the month of October, 2005

ChipMOS TECHNOLOGIES (Bermuda) LTD.

(Translation of Registrant's Name Into English)

**No. 1, R&D Road 1
Hsinchu Science Park
Hsinchu, Taiwan
Republic of China**

(Address of Principal Executive Offices)

(Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.)

Form 20-F Form 40-F

(Indicate by check mark whether the registrant by furnishing the information contained in this form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.)

Yes No

(If "Yes" is marked, indicate below the file number assigned to the registrant in connection with Rule 12g3-2(b):
82-____.)

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

ChipMOS TECHNOLOGIES (Bermuda) LTD.

(Registrant)

Date: October 18, 2005

By /S/ S.J. Cheng

Name: S.J. Cheng
Title: Chairman & Chief Executive Officer

**Exhibit
Number**

1.1 Press Release

Contact:**In Taiwan R.O.C.**

Dr. S.K. Chen

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The Ruth Group

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dpasquale@theruthgroup.com**ChipMOS TO HOLD ANNUAL TECHNICAL SYMPOSIUM IN SHANGHAI**

Hsinchu, Taiwan, October 18, 2005 – ChipMOS TECHNOLOGIES (Bermuda) LTD. (“ChipMOS” or “the Company”) (Nasdaq: IMOS) today announced that it will host its annual technical symposium at the Grand Hyatt Shanghai in Shanghai, China on November 4, 2005. Over 200 participants are expected to attend the full day symposium, which will focus on green packaging and modules and LCD driver IC related topics covering front-end, back-end, as well as market and application trends. In addition to ChipMOS executives, speakers will feature the company’s customers, suppliers and project partners, including Shanghai SVA NEC, NewVision, Sumitomo Bakelite, Himax Display and Shanghai Jiaotong University. Simultaneous Chinese to English translation will be available.

S.J. Cheng, Chairman and Chief Executive Officer of ChipMOS said, “This is a successful event for us each year and gives us an opportunity to showcase our technology strength and impressive partnerships. As in prior years, our annual technical symposium is a great platform for participants in the IC industry to interact with one another and to share their unique experiences and technical expertise.”

For the agenda of topics and speakers, on-line registration form and other information please visit our company website at <http://www.chipmos.com.tw>.

About ChipMOS TECHNOLOGIES (Bermuda) LTD.:

ChipMOS (<http://www.chipmos.com.tw>) is a leading independent provider of semiconductor testing and assembly services primarily to customers in Taiwan, Japan, and the U.S. With advanced facilities in Hsinchu and Southern Taiwan Science Parks in Taiwan and in Shanghai, ChipMOS and its subsidiaries provide testing and assembly services to a broad range of customers, including leading fabless semiconductor companies, integrated device manufacturers and independent semiconductor foundries.

Forward-Looking Statements

Certain statements contained in this announcement may be viewed as “forward-looking statements” within the meaning of Section 27A of the U.S. Securities Act of 1933, as amended, and Section 21E of the U.S. Securities Exchange Act of 1934, as amended. Such forward-looking statements involve known and unknown risks, uncertainties and other factors, which may cause the actual performance, financial condition or results of operations of the Company to be materially different from any future performance, financial condition or results of operations implied by such forward-looking statements. Further information regarding these risks, uncertainties and other factors is included in the Company’s most recent Annual Report on Form 20-F filed with the U.S. Securities and Exchange Commission (the “SEC”) and in the Company’s other filings with the SEC.